Unit: mm

TOSHIBA Photocoupler Photorelay

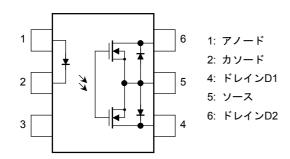
# **TLP4592G**

# Telecommunication Measurement Equipment Security Equipment FA

The Toshiba TLP4592G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a DIP package.

- 6-pin DIP (DIP6)
- Normally closed (1-form-B) device
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 100 mA (max)
- On-state resistance:  $50 \Omega$  (max)
- Isolation voltage: 2500 Vrms (min)

### Pin Configuration (top view)



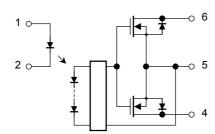
# 7.12±0.25 1 2 3 2.54±0.25 2.54±0.25 2.54±0.25 2.54±0.25 2.54±0.25

11-7A8

Weight: 0.4 g (typ.)

JEITA TOSHIBA

#### **Schematic**



# **Maximum Ratings (Ta = 25°C)**

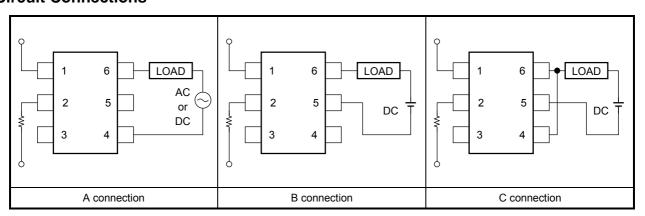
	Characteristics	Symbol	Rating	Unit		
	Forward current	lF	50	mA		
	Forward current derating (Ta	ΔI <sub>F</sub> /°C	-0.5	mA/°C		
LED	Peak forward current (100 μs	s pulse, 100 pps)	I <sub>FP</sub>	1	Α	
	Reverse voltage		V <sub>R</sub>	5	V	
	Junction temperature	Tj	125	°C		
	Off-state output terminal volt	age	V <sub>OFF</sub>	350	V	
	On-state current	A connection		100		
		B connection	I <sub>ON</sub>	100	mA	
Detector		C connection		200		
Dete	On-state current derating (Ta ≧ 25°C)	A connection		-1.0		
		B connection	$\Delta I_{ON}/^{\circ}C$	-1.0	mA/°C	
	( )	C connection		-2.0		
	Junction temperature		Tj	125	°C	
Storage temperature range			T <sub>stg</sub>	stg –55 to 125		
Operating temperature range			T <sub>opr</sub>	-40 to 85	°C	
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	°C	
Isola	tion voltage (AC, 1 min, R.H.	≦ 60%) (Note 1)	BVS	2500	Vrms	

Note 1: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

# **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	_	280	V
Forward current	lF	5	_	25	mA
On-state current	I <sub>ON</sub>	_	_	100	mA
Operating temperature	T <sub>opr</sub>	-20		65	°C

#### **Circuit Connections**



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# **Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 20 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V		_	10	μА
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz	_	30	_	pF
Detector	Off-state current	l <sub>OFF</sub>	V <sub>OFF</sub> = 350 V, I <sub>F</sub> = 5 mA	_	_	1	μА
Dete	Capacitance	C <sub>OFF</sub>	V = 0, f = 1 MHz, I <sub>F</sub> = 5 mA	_	30	_	pF

# **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	_	1	3	mA
Return LED current		I <sub>FT</sub>	I <sub>ON</sub> = 100 mA	0.1	_	_	mA
	A connection		I <sub>ON</sub> = 100 mA	_	27	50	
On-state resistance	B connection	R <sub>ON</sub>	I <sub>ON</sub> = 100 mA	_	20	43	Ω
	C connection		I <sub>ON</sub> = 200 mA	_	10	_	

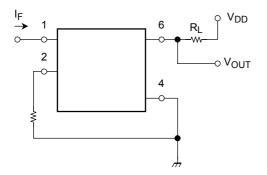
# Isolation Characteristics (Ta = 25°C)

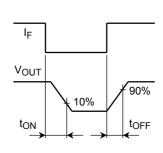
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≦ 60%	$5\times10^{10}$	10 <sup>14</sup>	_	Ω
		AC, 1 min	2500	_	_	Vrms
Isolation voltage	BVS	AC, 1 s, in oil	_	5000	_	
		DC, 1 min, in oil	_	5000	_	Vdc

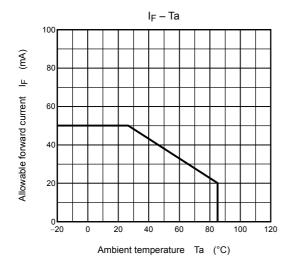
# **Switching Characteristics (Ta = 25°C)**

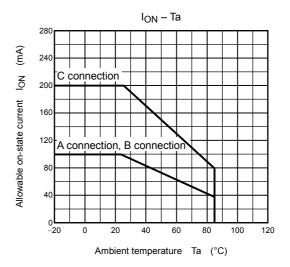
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t <sub>ON</sub>	$R_L = 200 \Omega$	_	0.25	0.5	ms
Turn-off time	tOFF	$V_{DD}^{-} = 20 \text{ V, I}_{F} = 5 \text{ mA}$ (Note 2)	_	0.5	1	ms

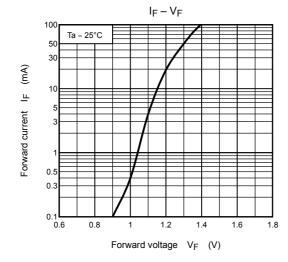
Note 2: Switching time test circuit



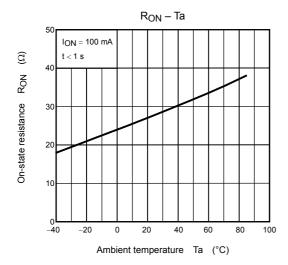


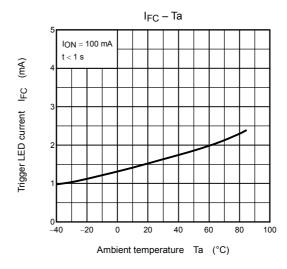


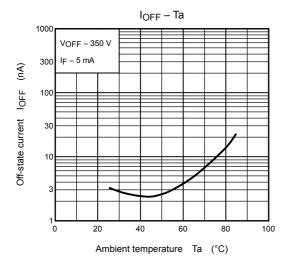


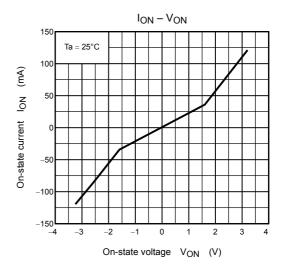


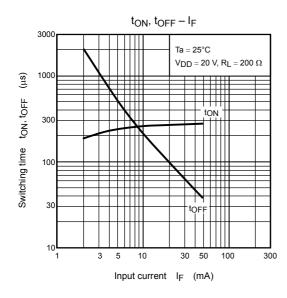
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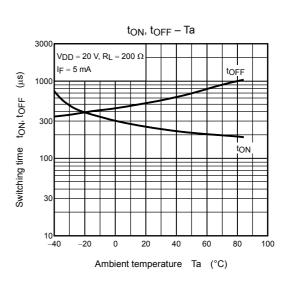












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